HDC2080EVM User 's Guide

User's Guide



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HDC2080EVM User 's Guide

1 Introduction

The Texas Instruments HDC2080EVM evaluation module (EVM) enables designers to evaluate the operation and performance of the HDC2080 Relative Humidity and Temperature Sensor.

The EVM contains one HDC2080 (See Table 1).

Table 1. Device and Package Configurations

DEVICE	IC	PACKAGE
U1	HDC2080DMBR	PWSON (6-pin) DMB

The EVM hosts an MSP430F5528 microcontroller (μ C) as well as the HDC2080. The μ C is used to control the HDC2080 and communicate with a host PC through a USB port. The EVM is designed to be broken into two sections if desired. The sensor section can be separated from the μ C section so that the user can remotely locate the sensor from the μ C section.

2 Setup

This section describes the connectors on the EVM as well and how to properly connect, setup and use the HDC2080EVM.

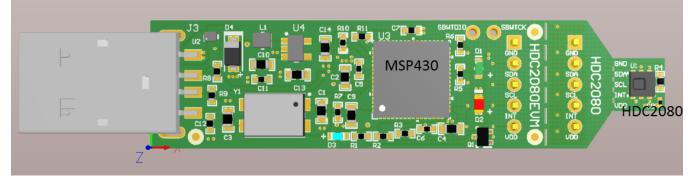


Figure 1. HDC2080EVM

2.1 Input/Output Connector Description

2.1.1 J1 – 5x1 Header

This header is not populated and can be installed if the EVM is broken in 2 sections: PC interface and Sensor. This connector with its counterpart J2 allows the communication of the two sections through a 5-wire cable

J1.1	GND
J1.2	SDA
J1.3	SCL
J1.4	INT
J1.5	VDD

2.1.2 J2 – 5x1 Header

This header is not populated and can be installed if the EVM is broken in 2 sections: PC interface and Sensor. This connector with its counterpart J1 allows the communication of the two sections through a 5-wire cable.

J2.1	GND
J2.2	SDA
J2.3	SCL
J2.4	INT
J2.5	VDD

2.1.3 USB Type A Connector

This connector is used for communications with the PC and provides power for the EVM.

2.2 Hardware Setup

The HDC2080EVM power is supplied via the USB connector. The LDO (U4) converts the 5V from the USB to 3.3V used by the HDC2080 and the MSP430. The EVM may be directly inserted into a USB port on a PC or laptop, or may be connected to the latter using the appropriate USB cable.

The I2C address of the HDC2080 is set at EVM level at 1000000xb on the EVM. The I2C address has been set mounting the 0 Ω resistor R12 (refer to Figure 2).

3



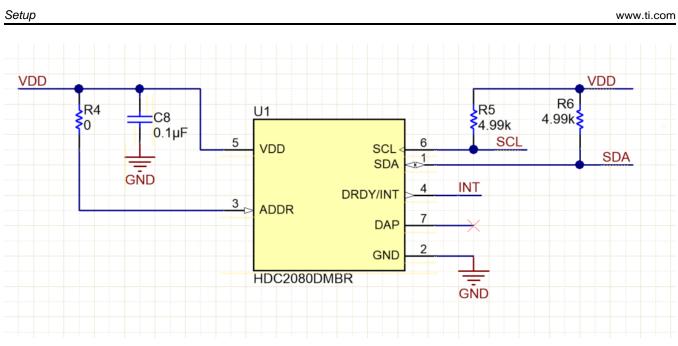


Figure 2. HDC2080EVM : Sensor Module

To change the I2C address, remove the resistor R12 and populate the R4 with 0 Ω resistor (refer to Figure 3)



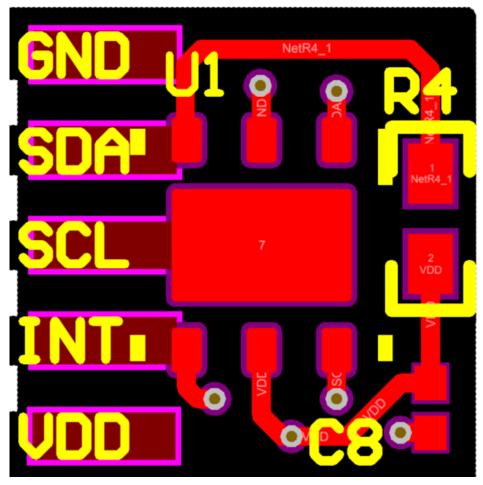


Figure 3. HDC2080EVM: Layout Resistors for I2C Address Setting - Top

Table 2. I2C Address

ADDR	R12	R4	HDC2080 ADDRESS
0	Short	Open	1000000
1	Open	Short	1000001

In Table 2, the EVM default configuration is in **bold**.



2.3 Software Setup

Setup

2.3.1 System Requirements

The Sensing Solutions GUI supports:

- 64-bit Windows 7
- 64-bit Windows XP

The current GUI does not support 32-bit Windows operating systems. The host machine is required for device configuration and data streaming. The following steps are necessary to prepare the EVM for the GUI:

- The GUI and EVM driver must be installed on the host.
- The EVM must be connected to a full speed USB port (USB 1.0 or above).

2.3.2 Sensing Solutions GUI and EVM Driver Installation

The Sensing Solutions GUI and EVM driver installer is packaged in a zip file. Follow these steps to install the software.

- 1. Download the software ZIP file from the EVM tool page
- 2. Extract the downloaded ZIP file
- 3. Run the included executable
- 4. Follow all directions from the installer

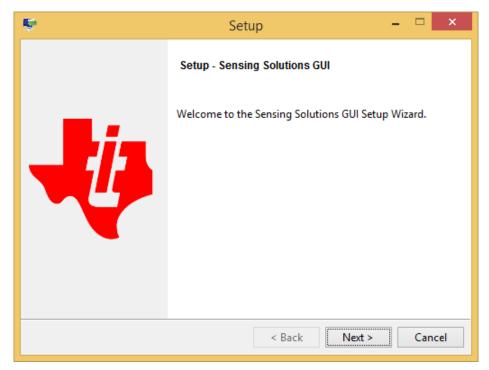


Figure 4. GUI Installer Welcome Page

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Read the license agreement and if you still wish to install the software, select "I accept the agreement" and click "Next" as shown in



Figure 5. GUI Installer License Agreement

6. Select the installation directory. If the user installing the software is not a system administrator a directory not with "Program Files" must be chosen instead of the default.

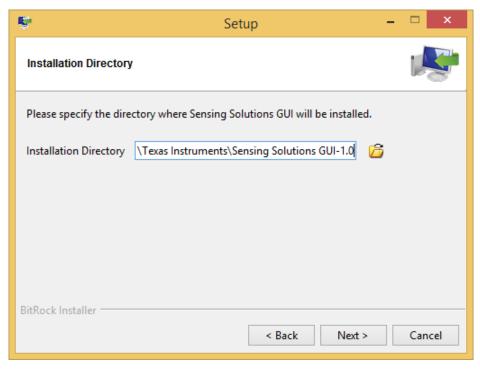


Figure 6. GUI Installer Installation Directory

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7. Wait for all files to install

5	Setup	-	×	
Installing	salling se wait while Setup installs Sensing Solutions GUI on your computer. Installing Unpacking C:\Program []utions GUI-1.0\PC GUI\msp430-tools\symbol.pyc			
Please wait while Setup installs Sensing S	olutions GUI on your co	omputer.		
	Installing			
	-	0-tools\symbol	ol.pvc	
			17	
BitRock Installer				
	< Back	Next >	Cancel	

Figure 7. GUI Installer Copying Files

8. After the files have copied a device driver installer will start. If prompted about an unsigned driver, choose to install the driver anyways. If running Windows 8 or 8.1, the PC must be started in a "Safe" mode to install the unsigned driver.



Figure 8. EVM Driver Installer Welcome Page



9. Wait for the driver to install

Device Driver Installation Wizard
The drivers are now installing
Please wait while the drivers install. This may take some time to complete.
< <u>B</u> ack <u>N</u> ext > Cancel

Figure 9. EVM Driver Installer In Progress

10. Click "Finish" after the driver has been installed



Figure 10. EVM Driver Installer Complete

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11. Click "Finish" to complete the software installation

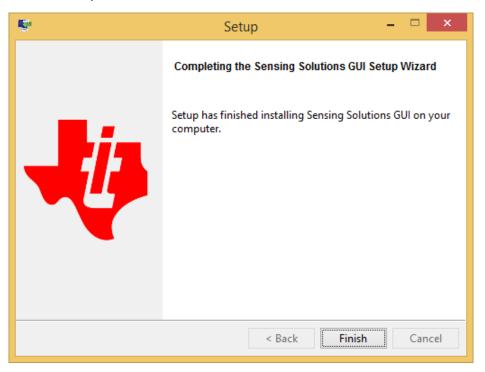


Figure 11. GUI Installer Complete

2.4 Operation

When the EVM is connected, the host computer will automatically detect the device and Launch the GUI. A detailed description of the GUI operation is presented later in this document.



2.5 Reducing the Sensor Thermal Mass

The HDC2080EVM can be broken into 2 sections to isolate the thermal mass of the μ C from the HDC2080. Figure 12 shows the board perforations that allow the two sections to be broken apart.

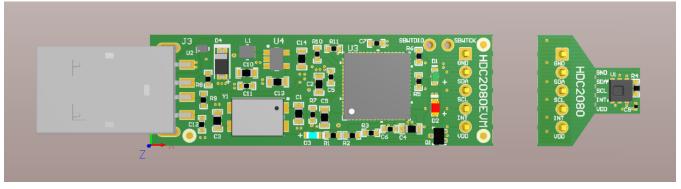


Figure 12. HDC2080EVM : PC Interface and Sensor Module

The communication between the two modules is ensured through the connector J1 and J2 and a 5-wire cable. In this configuration the thermal mass of the EVM is dramatically reduced, improving the temperature measurements performances of the HDC2080. The cable connecting J1 to J2 must conform to I2C cable length constraints. When used in this configuration, the GUI can still be used to communicate with the EVM and collect data.

If the thermal mass of the sensor section is still excessive, the sensor section can be reduced by breaking it at the perforation shown in Figure 13. The PCB segment that hosts the HDC2080 is 5.5mm x 5mm.



Figure 13. HDC2080EVM : PC Interface and Smaller Sensor Module

Also in the case where the EVM is broken in 2 sections it is still possible to use the GUI (ensuring the connections between the modules) or alternatively it is possible to connect the sensor module to a custom micro-controller. (Refer to Figure 14).



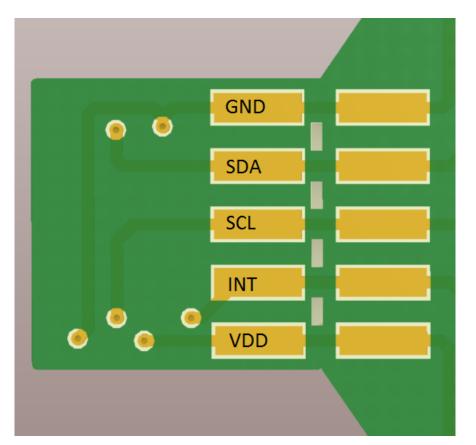


Figure 14. HDC2080EVM : Pads for I2C and Supply of the Smaller Sensor Module



3 GUI Operation

The section describes how to use the GUI

3.1 Starting the GUI

Follow these steps to start the GUI:

- 1. Select the windows start menu
- 2. Select "All programs"
- 3. Select the "Texas Instruments" folder
- 4. Select the Sensing Solutions GUI
- 5. Click "Sensing Solutions GUI"
- 6. Splash screen will appear for at least two seconds.
 - Slower PC's may show a blank splash screen without any texts for up to 20 seconds

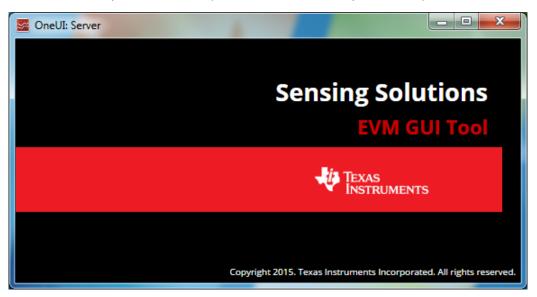


Figure 15. GUI Splash Screen



GUI Operation

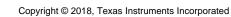
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7. After the splash screen is displayed the main window will open. Note: Only one instance of the GUI may be opened at a time!

DneUI Application		
MENU Sensing Solutions EVM GUI	v1.	9.1
Introduction to Inductive Sensing		
Inductive sensing is a highly reliable solution for detecting the position of conductive materials using a simple wire wound coil, PCB coil, or spring. By configuring the coil and target shap sensing can be applied to many different applications that require proximity measurement, rotational and linear position sensing, as well as simple event counting.	e, inductiv	е
Overall reliability is improved and system cost is reduced with the integration of multiple channels making this an attractive solution for metal buttons, motor position, bill counting, lens many other applications.	osition, an	d
Introduction to Capacitive Sensing		
Capacitive sensing is a high-resolution, low-cost contactless sensing technique that can be applied to a variety of applications such as liquid level sensing, proximity sensing, gesture re ice/rain detection and collision avoidance.	ognition,	
The sensor in a capacitive sensing system is any conductor, such as copper on PCB, conductive ink or a piece of metal, allowing for low cost and highly flexible system design. This co as a proximity sensor or liquid level sensor depending on the use case.	ductor act	ŝ
Introduction to Humidity Sensing		
Humidity affects many properties of air, and of materials in contact with air. Water vapor is a key agent in both weather and climate, and it is an important atmospheric greenhouse gas measurements are used wherever there is a need to prevent condensation, corrosion, mold, warping or other spoilage of products. This is highly relevant for foods, pharmaceuticals, c fuels, wood, paper, and many other products. Air-conditioning systems in buildings often control humidity, and significant energy goes into cooling the air to remove water vapor. Humic measurements are necessary to maintain comfortable environmental conditions. An accurate humidity sensor can work in synergy with heating and cooling systems to reduce a buildin footprint.	nemicals, ity	
Benefits of TI technology and the FDC2x14 and FDC2x12 Families		
Not connected Ready TEXAS	NSTRU	MEI
Figure 16. GUI Introduction Page		



GUI Operation

3.2 Connecting the EVM

Follow these steps to connect the EVM to the GUI:

- 1. Attach the EVM to the computer via the USB port.
- 2. The GUI always shows the connection status on the bottom left corner of the GUI
 - The initial release of this GUI does not support multiple GUI instances or multiple devices. To control multiple EVMs, virtual machines may be used or multiple PC's are required. Future releases will support multiple EVMs from a single instance of the GUI.

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Introduction to Inductive Sensing	Î
Inductive sensing is a highly reliable solution for detecting the position of conductive materials using a simple wire wound coil, PCB coil, or spring. By configuring the coil and target shape, induct sensing can be applied to many different applications that require proximity measurement, rotational and linear position sensing, as well as simple event counting.	ve
Overall reliability is improved and system cost is reduced with the integration of multiple channels making this an attractive solution for metal buttons, motor position, bill counting, lens position, a many other applications.	nd
Introduction to Capacitive Sensing	
Capacitive sensing is a high-resolution, low-cost contactless sensing technique that can be applied to a variety of applications such as liquid level sensing, proximity sensing, gesture recognition ice/rain detection and collision avoidance.	
The sensor in a capacitive sensing system is any conductor, such as copper on PCB, conductive ink or a piece of metal, allowing for low cost and highly flexible system design. This conductor as as a proximity sensor or liquid level sensor depending on the use case.	:ts
Introduction to Humidity Sensing	
Humidity affects many properties of air, and of materials in contact with air. Water vapor is a key agent in both weather and climate, and it is an important atmospheric greenhouse gas. Humidity measurements are used unerever there is a need to prevent condensation, corrosion, mold, warping or other spoilage of products. This is highly relevant for foods, pharmaceuticals, chemicals, fuels, wood, paper, apr many other products. Air-conditioning systems in buildings often control humidity, and significant energy goes into cooling the air to remove water vapor. Humidity measurements are necessary to maintain comfortable environmental conditions. An accurate humidity sensor can work in synergy with heating and cooling systems to reduce a building energy footprint.	
Benefits of TI technology and the FDC2x14 and FDC2x12 Families	
Not connected Ready	JMENTS

Figure 17. GUI Disconnected from EVM



GUI Operation

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roduction to Ind	uctive Sensing				
	• •		a simple wire wound coil, PCB coil, or sp I and linear position sensing, as well as s		i shape, inductive
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asurements are u els, wood, paper, a	used unerever there is a need to preven apermany other products. Air-conditionin	condensation, corrosion, mold, warping g systems in buildings often control hum	ent in both weather and climate, and it is g or other spoilage of products. This is h nidity, and significant energy goes into co ity sensor can work in synergy with heat	ghly relevant for foods, pharmaceutica oling the air to remove water vapor. H	als, chemicals, lumidity
nefits of 11 tech	nology and the FDC2x14 and FDC2	x12 Families			

Figure 18. GUI Connected from EVM

3.3 Navigating the GUI

- To navigate to different pages of the GUI follow these steps:
- 1. Click "Menu" in the upper left corner

2	OneUI Application			×
E	MENU Sensing Solutions EVM GUI	v1.	9.1	
Ν	Introduction to Inductive Sensing			^
	Inductive sensing is a highly remote solution for detecting the position of conductive materials using a simple wire wound coil, PCB coil, or spring. By configuring the coil and target shape, setsing can be applied to many different applications that require proximity measurement, rotational and linear position sensing, as well as simple event counting.	inductiv	e	
	Overall reliability is improved and system cost is reduced with the integration of multiple channels making this an attractive solution for metal buttons, motor position, bill counting, lens position and other applications.	tion, an	d	
	Introduction & Capacitive Sensing			
	Capacitive sensings a herein detection and control of the sensor in a capacity of applications such as liquid level sensing, proximity sensing, gesture recognised to a variety of applications such as liquid level sensing, proximity sensing, gesture recognised to a variety of applications such as liquid level sensing, proximity sensing, gesture recognised to a variety of applications such as liquid level sensing, proximity sensing, gesture recognised to a variety of applications such as liquid level sensing, proximity sensing, gesture recognised to a variety of applications such as liquid level sensing, proximity sensing, gesture recognised to a variety of applications such as liquid level sensing, proximity sensing, gesture recognised to a variety of applications such as liquid level sensing, proximity sensing, gesture recognised to a variety of applications such as liquid level sensing, proximity sensing, gesture recognised to a variety of applications such as liquid level sensing, proximity sensing, gesture recognised to a variety of applications such as liquid level sensing, proximity sensing, gesture recognised to a variety of applications such as liquid level sensing, proximity sensing, gesture recognised to a variety of applications such as liquid level sensing. This conductive ink or a piece of metal, allowing for low cost and highly flexible system design. This conductive ink or a proximity sensor or liquid level sensor depending on the use case.		s	
	Introduction to Humidity Sensing			
	Humidity affects many properties of air, and of materials in contact with air. Water vapor is a key agent in both weather and climate, and it is an important atmospheric greenhouse gas. Hu measurements are used wherever there is a need to prevent condensation, corrosion, mold, warping or other spoilage of products. This is highly relevant for foods, pharmaceuticals, chen fuels, wood, paper, and many other products. Air-conditioning systems in buildings often control humidity, and significant energy goes into cooling the air to remove water vapor. Humidity measurements are necessary to maintain comfortable environmental conditions. An accurate humidity sensor can work in synergy with heating and cooling systems to reduce a building of footprint.	nicals,		
	Benefits of TI technology and the FDC2x14 and FDC2x12 Families			
•	Connected SSP EVM connected - HDC20x0	STRU	MEN	ITS

Figure 19. GUI Menu Button



GUI Operation

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2. Select the desired page from the menu shown on the left

MoneUI Application	
≡ MENU	Sensing Solutions EVM GUI v1.9.1
Introduction	ing
Device	ble solution for detecting the position of conductive materials using a simple wire wound coil, PCB coil, or spring. By configuring the coil and target shape, inductive ifferent applications that require proximity measurement, rotational and linear position sensing, as well as simple event counting.
EVM	system cost is reduced with the integration of multiple channels making this an attractive solution for metal buttons, motor position, bill counting, lens position, and
Registers	
Configuration	nsing
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1 Firmware	Introduction .ing Introduction ble solution for detecting the position of conductive materials using a simple wire wound coil, PCB coil, or spring. By configuring the coil and target shape, inductive inferent applications that require proximity measurement, rotational and linear position sensing, as well as simple event counting. I Device ble solution for detecting the position of conductive materials using a simple wire wound coil, PCB coil, or spring. By configuring the coil and target shape, inductive inferent applications that require proximity measurement, rotational and linear position sensing, as well as simple event counting. I EVM system cost is reduced with the integration of multiple channels making this an attractive solution for metal buttons, motor position, bill counting, lens position, and exercises Registers
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	er there is a need to prevent condensation, corrosion, mold, warping or other spoilage of products. This is highly relevant for foods, pharmaceuticals, chemicals, her products. Air-conditioning systems in buildings often control humidity, and significant energy goes into cooling the air to remove water vapor. Humidity
	the FDC2x14 and FDC2x12 Families
Connected SSP EV	M connected - HDC20x0

Figure 20. GUI Navigation Menu

3.4 Configuring the Device Using Register Page

The register page allows users to control the device directly with the register values. The user may also use this page to read the current register values on the device.

3.4.1 Automatically Updating GUI Register Values Using Auto-Read

Autoread will periodically request the register values on the device. Click the dropdown box next to "Auto Read" to select the update interval.

MENU Sensing	g Solutions EVM GUI									v1.9.1	
Registers											
Auto Read Every 1 sec Off Every 1/4 sec Every 1/2 sec Every 1 sec Write RE Every 5 sec egister Updat	e Mode∷ Immediate ▼										
Register	Address	Current Value				E	Bits			1	Ī
TEMPERATURE LOW	0x00	0x0b	7	6	5	4	3	2	1	0	l
TEMPERATURE HIGH	0x00	0x68	0	1	1	0	1	0	0	0	
HUMIDITY LOW	0x02	0x5d	0	1	0	1	1	1	0	1	
HUMIDITY HIGH	0x03	0x91	1	0	0	1	0	0	0	1	
INTERRUPT/DRDY	0x04	0x20	0	0	1	0	0	0	0	0	
TEMPERATURE MAX	0x05	0x69	0	1	1	0	1	0	0	1	1
HUMIDITY MAX	0x06	0x9d	1	0	0	1	1	1	0	1	1
INTERRUPT MASK	0x07	0x40	0	1	0	0	0	0	0	0	
TEMPERATURE OFFSET	0x08	0x00	0	0	0	0	0	0	0	0	
HUMIDITY OFFSET	0x09	0x00	0	0	0	0	0	0	0	0	
TEMP THRESHOLD LOW	0x0A	0x8e	1	0	0	0	1	1	1	0	
TEMP THRESHOLD HIGH	0x0B	0x6c	0	1	1	0	1	1	0	0	

Figure 21. Selecting Auto-Read Interval on Register Page

3.4.2 Manually Updating Device Register Values

There are two methods to change register values: update the entire register value or change a single bit within the register. The recommended update mode is always "Immediate" and not "Deferred". To update register values, follow these steps.

1. Double-click the current value of the register that needs to be changed. The text will turn into an editable text box

GUI Operation



GUI Operation

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neUI Application										- •	
	ng Solutions EVM									v1.9.1	
TEMPERATURE LOW	0x00	0x55	0	1	0	1	0	1	0	1	
TEMPERATURE HIGH	0x01	0x68	0	1	1	0	1	0	0	0	
HUMIDITY LOW	0x02	0x15	0	0	0	1	0	1	0	1	
HUMIDITY HIGH	0x03	0x8f	1	0	0	0	1	1	1	1	
INTERRUPT/DRDY	0x04	0x00	0	0	0	0	0	0	0	0	
TEMPERATURE MAX	0x05	0x69	0	1	1	0	1	0	0	1]
HUMIDITY MAX	0x06	0x9d	1	0	0	1	1	1	0	1	
INTERRUPT MASK	0x07	0x40	0	1	0	0	0	0	0	0	
TEMPERATURE OFFSET	0x08	0x00	0	0	0	0	0	0	0	0	1
HUMIDITY OFFSET	0x09	0x00	0	0	0	0	0	0	0	0	
TEMP THRESHOLD LOW	0x0A	0x8e	1	0	0	0	1	1	1	0	
TEMP THRESHOLD HIGH	0x0B	0x6c	0	1	1	0	1	1	0	0	
HUMIDITY THRESHOLD LOW	0x0C	0x00	0	0	0	0	0	0	0	0	
HUMIDITY THRESHOLD HIGH	0x0D	Oxff	1	1	1	1	1	1	1	1	
CONFIGURATION	0x0E	0x57	0	1	0	1	0	1	1	1	
MEASURAMENT CONFIGURATION	0x0F	0x00	0	0	0	0	0	0	0	0	1
SERIAL_ID_0_7	0xF4	0x00	0	0	0	0	0	0	0	0	
SERIAL_ID_8_15	0xF5	0x00	0	0	0	0	0	0	0	0	
SERIAL_ID_16_23	0xF6	0x00	0	0	0	0	0	0	0	0	
SERIAL_ID_24_31	0xF7	0x00	0	0	0	0	0	0	0	0	1
SERIAL_ID_32_39	0xF8	0x00	0	0	0	0	0	0	0	0	

Figure 22. Selecting a Register's Current Value for Editing on Register Page

2. Type the new value in hexadecimal into the box and click enter. The text box changes to normal text and the GUI will send a command to the EVM to update the device register

MENU Sensin	g Solutions EVM	GUI								v1.9.1
TEMPERATURE LOW	0x00	0x7c	0	1	1	1	1	1	0	0
TEMPERATURE HIGH	0x01	0x68	0	1	1	0	1	0	0	0
HUMIDITY LOW	0x02	0x98	1	0	0	1	1	0	0	0
HUMIDITY HIGH	0x03	0x8e	1	0	0	0	1	1	1	0
INTERRUPT/DRDY	0x04	0x00	0	0	0	0	0	0	0	0
TEMPERATURE MAX	0x05	0x69	0	1	1	0	1	0	0	1
HUMIDITY MAX	0x06	0x9d	1	0	0	1	1	1	0	1
INTERRUPT MASK	0x07	0x40	0	1	0	0	0	0	0	0
TEMPERATURE OFFSET	0x08	0x00	0	0	0	0	0	0	0	0
HUMIDITY OFFSET	0x09	0x00	0	0	0	0	0	0	0	0
TEMP THRESHOLD LOW	0x0A	0x8e	1	0	0	0	1	1	1	0
TEMP THRESHOLD HIGH	0x0B	0x6c	0	1	1	0	1	1	0	0
HUMIDITY THRESHOLD LOW	0x0C	0x00	0	0	0	0	0	0	0	0
HUMIDITY THRESHOLD HIGH	0x0D	Oxff	1	1	1	1	1	1	1	1
CONFIGURATION	0x0E	0x07	0	0	0	0	0	1	1	1
MEASURAMENT CONFIGURATION	0x0F	0x00	0	0	0	0	0	0	0	0
SERIAL_ID_0_7	0xF4	0x00	0	0	0	0	0	0	0	0
SERIAL_ID_8_15	0xF5	0x00	0	0	0	0	0	0	0	0
SERIAL_ID_16_23	0xF6	0x00	0	0	0	0	0	0	0	0
SERIAL_ID_24_31	0xF7	0x00	0	0	0	0	0	0	0	0
SERIAL ID 32 39	0xF8	0x00	0	0	0	0	0	0	0	0

Figure 23. Entering New Value for Register on Register Page	Figure 23.	Entering Ne	w Value for	Register	on Register Page	Э
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MENU Sensing Se	olutions EVM GUI									v1.9.1	
TEMPERATURE LOW	0x00	0x7c	0	1	1	1	1	1	0	0	
TEMPERATURE HIGH	0x01	0x68	0	1	1	0	1	0	0	0	
HUMIDITY LOW	0x02	0x98	1	0	0	1	1	0	0	0	
HUMIDITY HIGH	0x03	0x8e	1	0	0	0	1	1	1	0	
NTERRUPT/DRDY	0x04	0x00	0	0	0	0	0	0	0	0	
TEMPERATURE MAX	0x05	0x69	0	1	1	0	1	0	0	1	1
HUMIDITY MAX	0x06	0x9d	1	0	0	1	1	1	0	1	1
NTERRUPT MASK	0x07	0x40	0	1	0	0	0	0	0	0	
TEMPERATURE OFFSET	0x08	0x00	0	0	0	0	0	0	0	0	1
HUMIDITY OFFSET	0x09	0x00	0	0	0	0	0	0	0	0	1
TEMP THRESHOLD LOW	0x0A	0x8e	1	0	0	0	1	1	1	0	1
TEMP THRESHOLD HIGH	0x0B	0x6c	0	1	1	0	1	1	0	0	1
HUMIDITY THRESHOLD LOW	0x0C	0x00	0	0	0	0	0	0	0	0	1
HUMIDITY THRESHOLD HIGH	0x0D	Oxff	1	1	1	1	1	1	1	1	1
CONFIGURATION	0x0E	0x07	0	0	0	0	0	1	1	1	
MEASURAMENT CONFIGURATION	0x0F	0x00	0	0	0	0	0	0	0	0	1
SERIAL_ID_0_7	0xF4	0x00	0	0	0	0	0	0	0	0	
SERIAL_ID_8_15	0xF5	0x00	0	0	0	0	0	0	0	0	
SERIAL_ID_16_23	0xF6	0x00	0	0	0	0	0	0	0	0	
SERIAL_ID_24_31	0xF7	0x00	0	0	0	0	0	0	0	0	
SERIAL_ID_32_39	0xF8	0x00	0	0	0	0	0	0	0	0	

Figure 24. Register Value Updated After Changing Value on Register Page

To change individual bit values rather that entire register values follow these steps.

1. Hover the mouse over the desired bit to change

	olutions EVM GUI									v1.9.1
	0x02	UXIC							0	0
HUMIDITY HIGH	0x03	0x9a	1	0	0	1	1	0	1	0
INTERRUPT/DRDY	0x04	0x20	0	0	1	0	0	0	0	0
TEMPERATURE MAX	0x05	0x69	0	1	1	0	1	0	0	1
HUMIDITY MAX	0x06	0xa3	1	0	1	0	0	0	1	1
INTERRUPT MASK	0x07	0x40	0	1	0	0	0	0	0	0
TEMPERATURE OFFSET	0x08	0x00	0	0	0	0	0	0	0	0
HUMIDITY OFFSET	0x09	0x00	0	0	0	0	0	0	0	0
TEMP THRESHOLD LOW	0x0A	0x8e	1	0	0	0	1	1	1	0
TEMP THRESHOLD HIGH	0x0B	0x6c	0	1	1	0	1	1	0	0
HUMIDITY THRESHOLD LOW	0x0C	0x00	0	0	0	0	0	0	0	0
HUMIDITY THRESHOLD HIGH	0x0D	Oxff	1	1	1	1	1	1	1	1
CONFIGURATION	0x0E	0x57	0	1	0	1	0	1	1	1
MEASURAMENT CONFIGURATION	0x0F	0x00	0	0	d's	0	0	0	0	0
SERIAL_ID_0_7	0xF4	0x00	0	0	0	0	0	0	0	0
SERIAL_ID_8_15	0xF5	0x00	0	0	0	0	0	0	0	0
SERIAL_ID_16_23	0xF6	0x00	0	0	0	0	0	0	0	0
SERIAL_ID_24_31	0xF7	0x00	0	0	0	0	0	0	0	0
SERIAL_ID_32_39	0xF8	0x00	0	0	0	0	0	0	0	0
SERIAL_ID_40_47	0xF9	0x00	0	0	0	0	0	0	0	0
SERIAL_ID_48_55	0xFA	0x00	0	0	0	0	0	0	0	0

Figure 25. Hovering Mouse Over Register Bit Value on Register Page



GUI Operation

2. Double-click the bit to toggle its value and the register's current value will update automatically

MENU Sensing S	olutions EVM GUI									v1.9.1	
AOMIDITY LOW	0x02	UXIC		1	1	1	1	1	0	0	
HUMIDITY HIGH	0x03	0x9a	1	0	0	1	1	0	1	0	
INTERRUPT/DRDY	0x04	0x20	0	0	1	0	0	0	0	0	
TEMPERATURE MAX	0x05	0x69	0	1	1	0	1	0	0	1	
HUMIDITY MAX	0x06	0xa3	1	0	1	0	0	0	1	1	
INTERRUPT MASK	0x07	0x40	0	1	0	0	0	0	0	0	
TEMPERATURE OFFSET	0x08	0x00	0	0	0	0	0	0	0	0	1
HUMIDITY OFFSET	0x09	0x00	0	0	0	0	0	0	0	0	1
TEMP THRESHOLD LOW	0x0A	0x8e	1	0	0	0	1	1	1	0	
TEMP THRESHOLD HIGH	0x0B	0x6c	0	1	1	0	1	1	0	0	1
HUMIDITY THRESHOLD LOW	0x0C	0x00	0	0	0	0	0	0	0	0	
HUMIDITY THRESHOLD HIGH	0x0D	0xff	1	1	1	1	1	1	1	1	1
CONFIGURATION	0x0E	0x77	0	1	1	1	0	1	1	1	
MEASURAMENT CONFIGURATION	0x0F	0x00	0	0	d's	0	0	0	0	0	1
SERIAL_ID_0_7	0xF4	0x00	0	0	0	0	0	0	0	0	
SERIAL_ID_8_15	0xF5	0x00	0	0	0	0	0	0	0	0	
SERIAL_ID_16_23	0xF6	0x00	0	0	0	0	0	0	0	0	
SERIAL_ID_24_31	0xF7	0x00	0	0	0	0	0	0	0	0	1
SERIAL_ID_32_39	0xF8	0x00	0	0	0	0	0	0	0	0	1
SERIAL_ID_40_47	0xF9	0x00	0	0	0	0	0	0	0	0	1
SERIAL_ID_48_55	0xFA	0x00	0	0	0	0	0	0	0	0	

Figure 26. Toggling Register Bit Value on Register Page

3.4.3 Reading Register Values without Auto-Read

To read register values follow these steps.

1. Select the register to update by clicking any column of the register row in the table



MENU Sensin	g Solutions EVM GUI									v1.9.1	
egisters											
Auto Read Every 1 sec 🔻											
Write Register 4 Read Register Updat	Address	Current Value				E	Bits			1	-
			7	6	5	4	3	2	1	0	
TEMPERATURE LOW	0x00	0x5c	0	1	0	1	1	1	0	0	
TEMPERATURE HIGH	0x01	0x68	0	1	1	0	1	0	0	0	
HUMIDITY LOW	0x02	0x53	0	1	0	1	0	0	1	1	
HUMIDITY HIGH	0x03	0x90	1	0	0	1	0	0	0	0	
INTERRUPT/DRDY	0x04	0x00	0	0	0	0	0	0	0	0	
TEMPERATURE MAX	0x05	0x69	0	1	1	0	1	0	0	1	
HUMIDITY MAX	0x06	0xa7	1	0	1	0	0	1	1	1	_
INTERRUPT MASK	0x07	0x40	0	1	0	0	0	0	0	0	
TEMPERATURE OFFSET	0x08	0x00	0	0	0	0	0	0	0	0	
HUMIDITY OFFSET	0x09	0x00	0	0	0	0	0	0	0	0	
		0x8e	1	0	0	0	1	1	1	0	-
TEMP THRESHOLD LOW	0x0A	UXDE									

Figure 27. Selecting a Register on Register Page

2. Click the "Read Register" button to update the selected register's current value and bit values in the table

MENU Sensin	g Solutions EVM GUI									v1.9.1	l
legisters											
Auto Read Every 1 sec 🔻]										
Write Register Y Read Register Upda Mm Register	ate Mode: Immediate Address	Current Value				E	lits				-
, i i i i i i i i i i i i i i i i i i i			7	6	5	4	3	2	1	0	
TEMPERATURE LOW	0x00	0x65	0	1	1	0	0	1	0	1	
TEMPERATURE HIGH	0x01	0x68	0	1	1	0	1	0	0	0	
HUMIDITY LOW	0x02	0x29	0	0	1	0	1	0	0	1	
HUMIDITY HIGH	0x03	0x90	1	0	0	1	0	0	0	0	
INTERRUPT/DRDY	0x04	0x20	0	0	1	0	0	0	0	0	
TEMPERATURE MAX	0x05	0x69	0	1	1	0	1	0	0	1	
HUMIDITY MAX	0x06	0xa7	1	0	1	0	0	1	1	1	
INTERRUPT MASK	0x07	0x40	0	1	0	0	0	0	0	0	
TEMPERATURE OFFSET	0x08	0x00	0	0	0	0	0	0	0	0	1
HUMIDITY OFFSET	0x09	0x00	0	0	0	0	0	0	0	0	
TEMP THRESHOLD LOW	0x0A	0x8e	1	0	0	0	1	1	1	0	
	0x0B	0x6c	0	1	1	0	1	1	0	0	

Figure 28. Reading the Current Device Register Value on Register Page

3.4.4 Saving Device Configuration

- To save the current register settings of the device follow these steps.
- 1. Click the button immediately right to the "Auto-Read" selection dropdown

MENU Sensin	g Solutions EVM GUI									v1.9.1	
legisters											
Auto Read Every 1 sec	e Mode∑Immediate ▼										
Register	Address	Current Value				E	Bits				Ē
			7	6	5	4	3	2	1	0	
TEMPERATURE LOW	0x00	0x92	1	0	0	1	0	0	1	0	
TEMPERATURE HIGH	0x01	0x68	0	1	1	0	1	0	0	0	
HUMIDITY LOW	0x02	0x9c	1	0	0	1	1	1	0	0	
HUMIDITY HIGH	0x03	0x94	1	0	0	1	0	1	0	0	
INTERRUPT/DRDY	0x04	0x20	0	0	1	0	0	0	0	0	
TEMPERATURE MAX	0x05	0x69	0	1	1	0	1	0	0	1	
HUMIDITY MAX	0x06	0xa7	1	0	1	0	0	1	1	1	
INTERRUPT MASK	0x07	0x40	0	1	0	0	0	0	0	0	
TEMPERATURE OFFSET	0x08	0x00	0	0	0	0	0	0	0	0	
HUMIDITY OFFSET	0x09	0x00	0	0	0	0	0	0	0	0	
TEMP THRESHOLD LOW	0x0A	0x8e	1	0	0	0	1	1	1	0	
											11

Figure 29. Save Register Values to File on Register Page



2. Choose a JSON file name and the directory to save it within. Then click "Save"

Save As							×					v1.9.1	
🖉 🗸 🕷 OSDisk (C	:) 🕨 ti 🕨 Sensing Solutions EV	M GUI-1.9.1 ► PC GUI ►		Search	PC GUI		2						
Organize New folde	r					•	0						
*	Name	Date mo	odified	Туре		Size							
Uibraries	locales	12/6/20	16 3:22 PM	File folder									
Music	🐌 msp430-tools	12/6/20	16 3:23 PM	File folder									
Music Pictures	🐌 node_modules	12/6/20	16 3:22 PM	File folder									
S Videos	👢 public	12/6/20	16 3:23 PM	File folder			- 1		Bits				ī
S videos	📕 server	12/6/20	16 3:23 PM	File folder								0	ł.
Computer	package.json	10/9/20	15 7:43 PM	JSON File			2 KB	4	3	2	1	0	
SDisk (C:)								0	1	0	0	1	
							•	-	1	-	0	0	
-0221020 01 JE-E	•							0		0			
File name: regist	ers.json						•	0	1	1	1	1	
Save as type: JSON	File (.json)						-	0	0	0	0	0	
								0	1	1	1	1	
								0	0	1	1	1	1
						_		0	0	0	0	0	1
Hide Folders				<u>S</u> ave	ب ا ل	Cancel		0	0	0	0	0	1
HUMIDITY OFFSET		0x09	0x00		0	0	.:: 0	0	0	0	0	0	1
TEMP THRESHOLD LOW		0x0A	0x8e		1	0	0	0	1	1	1	0	-
TEMP THRESHOLD HIGH		0x0B	0x6c		0	1	1	0	1	1	0	0	-

Figure 30. Choosing a JSON File Name to Save Register Values

3.4.5 Loading Previously Saved Device Configuration

To load previously saved register settings from a JSON file follow these steps.

1. Click the button furthest right from the "Auto-Read" selection dropdown



GUI Operation

neUI Application MENU Sensing	g Solutions EVM GUI									v1.9.1
egisters										
Auto Read Every 1 sec 🔹 🛓										
Write Register Y Read Register Updat Register	Address	Current Value				E	Bits			
			7	6	5	4	3	2	1	0
TEMPERATURE LOW	0x00	0xd2	1	1	0	1	0	0	1	0
TEMPERATURE HIGH	0x01	0x68	0	1	1	0	1	0	0	0
HUMIDITY LOW	0x02	0x82	1	0	0	0	0	0	1	0
HUMIDITY HIGH	0x03	0x88	1	0	0	0	1	0	0	0
INTERRUPT/DRDY	0x04	0x20	0	0	1	0	0	0	0	0
TEMPERATURE MAX	0x05	0x6f	0	1	1	0	1	1	1	1
HUMIDITY MAX	0x06	0xa7	1	0	1	0	0	1	1	1
INTERRUPT MASK	0x07	0x40	0	1	0	0	0	0	0	0
TEMPERATURE OFFSET	0x08	0x00	0	0	0	0	0	0	0	0
HUMIDITY OFFSET	0x09	0x00	0	0	0	0	0	0	0	0
TEMP THRESHOLD LOW	0x0A	0x8e	1	0	0	0	1	1	1	0
								-		

Figure 31. Loading Previously Saved Register Values from File on Register Page

2. Select the JSON file with the desired settings and click "Open"

🚾 OneUI Application										[×
🚟 Open						×					v1.9.1	
OSDisk (C:)	▶ ti ▶ Sensing Solutions EVM GU	JI-1.9.1 ▶ PC GUI ▶	👻 🍫 Sear	ch PC GUI	1	٩						
Organize 🔹 New folder				•		0						11
★ Favorites	Name	Date modified	Туре		Size							
💻 Desktop	👢 locales	12/6/2016 3:22 PM	File folder									
🐌 Downloads	👢 msp430-tools	12/6/2016 3:23 PM	File folder									
Secent Places	locale node_modules	12/6/2016 3:22 PM	File folder									
Ξ	👢 public	12/6/2016 3:23 PM	File folder				F	Bits				-
📜 Libraries	👢 server	12/6/2016 3:23 PM	File folder				4	3	0	4	0	
Documents	package.json	10/9/2015 7:43 PM	JSON File			2 KB			2	1		1
🕹 Music	registers.json	7/7/2017 4:43 PM	JSON File			2 KB	1	0	0	0	1	
Sector Pictures							0	1	0	0	0	
Judeos							0	1	0	1	1	
K Computer							0	1	1	0	1	
Computer							0	0	0	0	0	
VFRBATIM HD (G * 4		III				•	0	1	1	1	1	
	registers.json			(.ison)		-	0	0	1	1	1	
-					Connect		0	0	0	0	0	
			<u>O</u> pen		Cancel		0	0	0	0	0	
HUMIDITY OFFSET		0x09 0x00		0	0	0	0	0	0	0	0	
TEMP THRESHOLD LOW		0x0A 0x8e		1	0	0	0	1	1	1	0	
TEMP THRESHOLD HIGH		0x0B 0x6c		0	1	1	0	1	1	0	0	
Connected Registers	refreshed.								i Tex	as Ins	TRUME	NTS

Figure 32. Selecting Previously Save Register Value JSON File



3.5 Configuring the Device using Configuration Page

The Sensing Solutions GUI is capable on configuring the device more intuitively than the direct register values. For more information about configuring the HDC2080 please reference the device datasheet.

2 OneUI Application		×	
MENU Sensing Solutions EVM GUI	v1.9.1		
Configuration		•	Î
Temperature Measurement Resolution			
14 bit 0 11 bit 8 bit			
Humidity Measurement Resolution			
14 bit 0 11 bit 8 bit			
Heater Enabled			
Disabled Enabled			
Mode of Acquisition			
Temperature + Humidity Temperature			
Humidity			
Output Data Rate			
◎ Single ◎ 1/120 Hz ◎ 1/60 Hz ◎ 0.1 Hz ◎ 0.2 Hz ◎ 1 Hz ◎ 2 Hz ⑧ 5 Hz			
Interrupt Enable			
○ High Z ● Enabled			
Interrupt Polarity			
O Active Low Active High			
Interrupt Mode			÷
Connected Registers refreshed.	NSTRUME	INTS	





GUI Operation

3.6 Streaming Measurement Data

The Sensing Solutions GUI and EVM provide a tool to capture measurement data at rates up to 500Hz. The section describes how to use the data measurement tools from the "Data Streaming" page accessible from the GUI menu.

3.6.1 Choosing Graph Units and Visible Channels

Select the drop down menu on top of the y-axis to choose the units of the graph. Available options include: Temperature and Humidity, and Raw Code.

See OneUI Application	
MENU Sensing Solutions EVM GUI	v1.9.1
Data Streaming: Start Stop	Show Graph Configuration (C) Show Statistics (I)
Temperature and Humidity Show: TEMPERATURE_CELCIUS ReLATIVE_HUMIDITY_PERCENT Raw Code	Select Log File: 📥 not logging data
0.9	
0.8	
0.7	
0.6	
0.4	
0.8	
0.2	
0.1	
0.0 0.1 0.2 0.3 0.4 0.5 0.6 0.7	0.8 0.9 1.0
S TEMPERATURE_CELCIUS S RELATIVE_NUMIDITY_PERCENT	900 1024 Range: 64
Connected Registers refreshed.	🐳 Texas Instruments

Figure 34. Selecting the Measurement Units for the Data Streaming Graph

To select which measurements are displayed in the graph, check or uncheck the temperature and relative humidity boxes shown next to the graph units. Selecting or not selecting the data types only affects the graph and not the data logged to a file. If a data type is not enabled in the Configuration page it will not appear on the Data Streaming page.



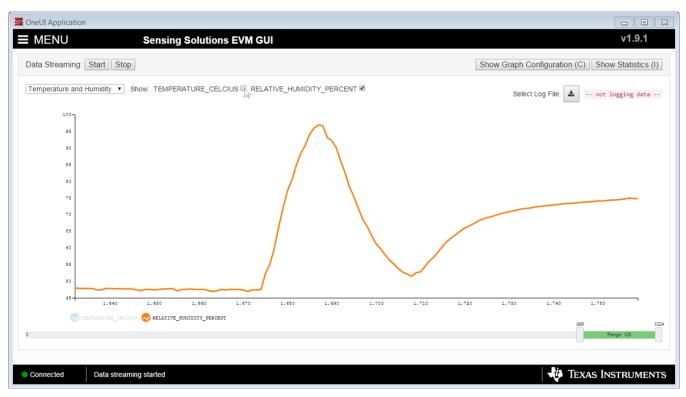
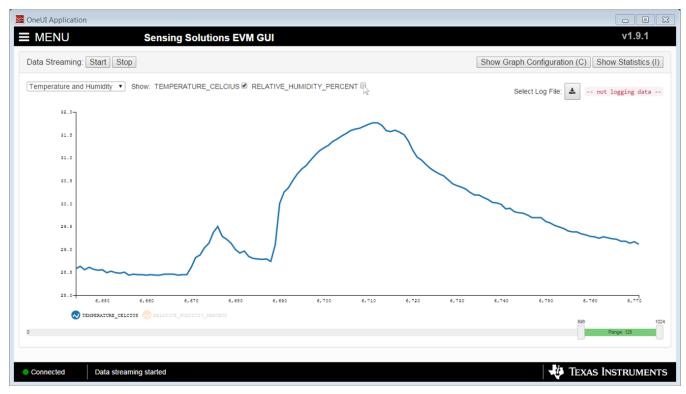


Figure 35. Data Streaming Graph Showing Only Relative Humidity Percent







GUI Operation

3.6.2 Logging Data to a File

Follow these steps to log measurement data to a file.

1. Click the button in the upper right under next to "Click to Select Log File"

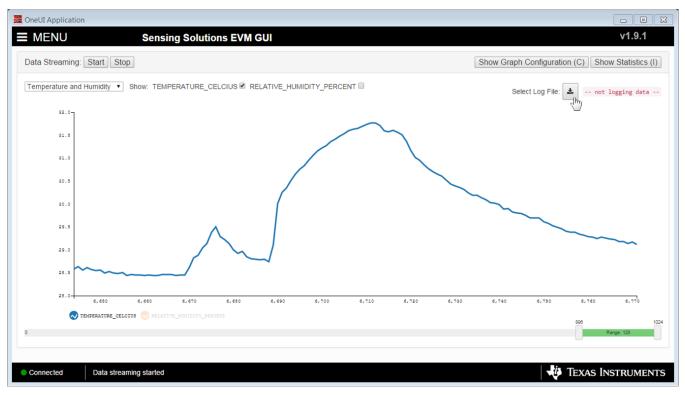


Figure 37. Select Log File Button on Data Streaming Page



GUI Operation

www.ti.com

2. Select a file name and directory to save the data to and then click the "Save" button

OneUI Application						- • ×
Save As					×	v1.9.1
🕞 🕞 – 👢 « OSDis	sk (C:) 🕨 ti 🕨 Sensing Solutions EVM GUI-1.9	0.1 ► PC GUI ►	✓ ⁴ → Search	PC GUI		01-1-1-1-1
Organize New for	older			≣ - (how Graph Configuration (C) Sho	w Statistics (I)
	^ Name	Date modified	Туре	Size	Select Log File: 🛓 not 1	logging data
闩 Libraries	locales	12/6/2016 3:22 PM	File folder			
Music	msp430-tools	12/6/2016 3:23 PM	File folder			
Music	loode_modules	12/6/2016 3:22 PM	File folder			
S Videos	🗉 📜 public	12/6/2016 3:23 PM	File folder			
Judeos	🔍 server	12/6/2016 3:23 PM	File folder			
Computer						
VERBATIM HD (G		III			•	
File name: da					•	
_	icrosoft Excel Comma Separated Values File				•	
bare as 3) per im						
Hide Folders			Save	Cancel	8,390 8,400 8,410	
Q						1024
Connected Dat	ta streaming started				Texas In	STRUMENTS

Figure 38. Selecting the Log File for Data Streaming

3.6.3 Setting the Vertical Axis Scale and Sampling Rate

To set the vertical axis scale or change the sampling rate follow these steps.

1. Click the "Show Graph Configuration" button



GUI Operation

www.ti.com

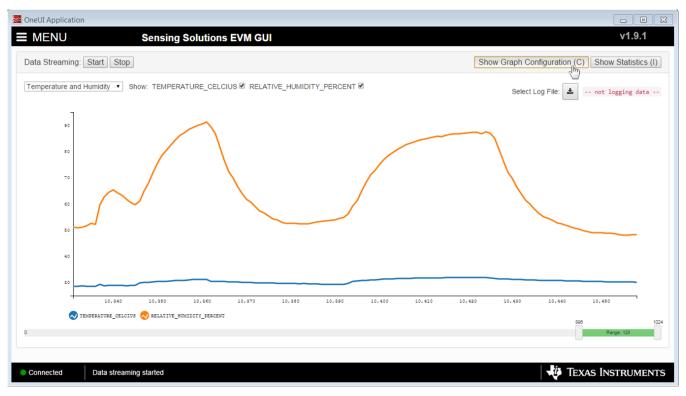
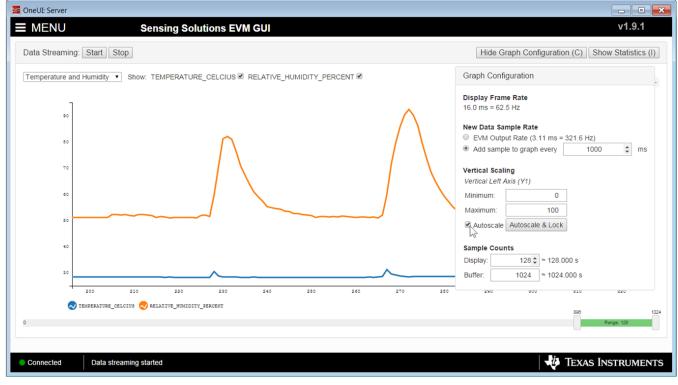


Figure 39. Show Graph Configuration Button on Data Streaming Page

- 2. The sampling rate can be adjusted in the "Sampling Rate" table.
 - Note that the GUI sampling rate affects only the graph and logging rate but not the actual device sampling rate







3. The vertical scaling can be automatically updated or manually controlled by selecting either checkbox in the "Vertical Scaling" table.

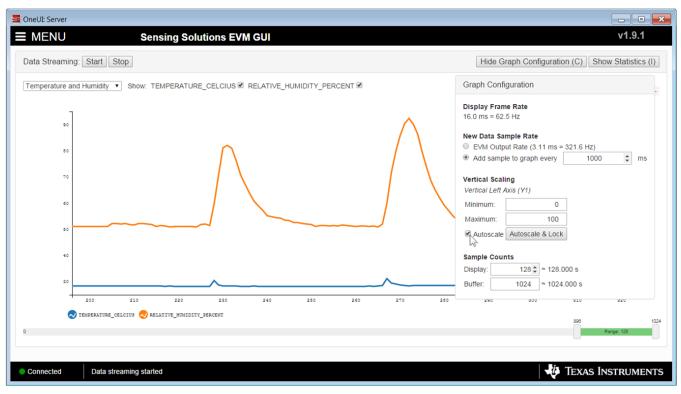


Figure 41. Manually Setting the Vertical Scale on Data Streaming Graph



3.6.4 Starting and Stopping Measurement Data Acquisition

To start data streaming click the "Start" button.

Server OneUI: Server									- • ×
	Sensing Solu	tions EVM 0	SUI						v1.9.1
Data Streaming: Start Stop						Sh	ow Graph Config	uration (C) Sho	w Statistics (I)
• Show:							Select Log F	File: 📥 not 3	logging data
0.0 0.1	0.2	0.3	0.4	0.5	0.6	0.7	0.8	0.9	1.0
0							384	Range: 128	512
Not connected SSP EVM disc	connected							🦆 Texas In	STRUMENTS

Figure 42. Starting Data Acquisition on Data Streaming Graph

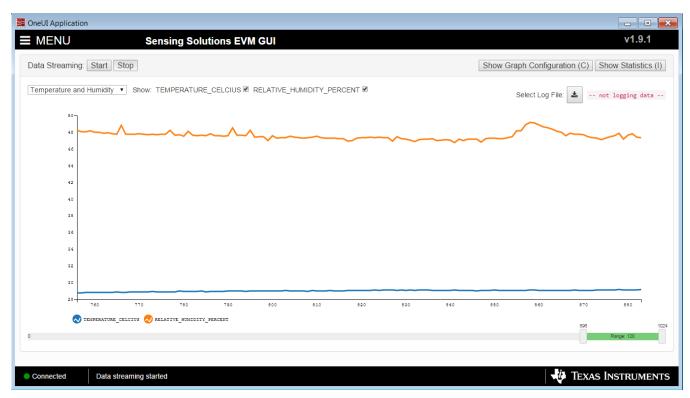


Figure 43. Data Acquisition In Progress on Data Streaming Page



To stop data streaming click the "Stop" button.

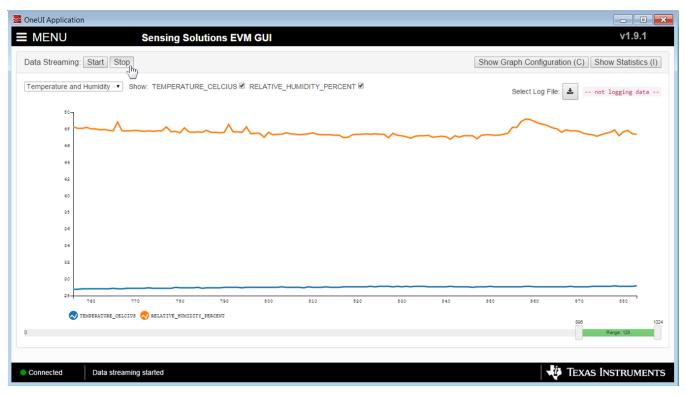


Figure 44. Stopping Data Acquisition on Data Streaming Graph

3.6.5 Displaying Measurement Data Statistics

Click the "Show Statistics" button to view the measurement statistics.



GUI Operation

www.ti.com

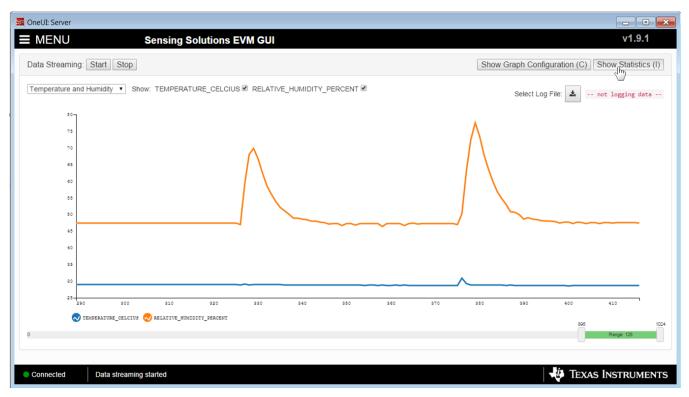


Figure 45. Show Statistics Button on Data Streaming Graph







3.6.6 Navigating the GUI's Data Buffer

After stopping the data stream, the number of data samples displayed can be selected by moving the dual slider under the graph.



Figure 47. Moving the Data Graph Sample View



GUI Operation

www.ti.com



Figure 48. Viewing the Entire Buffer on Data Graph

3.7 Updating the EVM Firmware

To upload new firmware to the EVM, navigate to the "Firmware" page from the GUI menu and follow these steps.

1. Click the button to select a TI-TXT firmware file



Market Construction	
MENU Sensing Solutions EVM GUI	v1.9.1
Firmware Upgrade	
Select TI-TXT firmware File:	
Connected SSP EVM connected - HDC20x0	s Instruments

Figure 49. Select TI-TXT File Button on Firmware Upload Page

2. Select the firmware file and click "Open"

OneUI Applicatio	n					
Open						×
>	OSDisk	: (C:)	▶ ti ▶ Sensing Solutions EVM GUI-1.9.1 ▶ EVM	A Firmware 🕨	✓ ← Search EVM	Firmware 🔎
Organize 🔹	New fo	lder			11 -	
☆ Favorites		-	Name	Date modified	Туре	Size
💻 Desktop			J FDC2x14_LDC13xxRevB_LDC16xxRevB_EV	12/6/2016 3:22 PM	File folder	
🔰 Download	s		HDC10x0_EVM_Firmware_source	12/6/2016 3:22 PM	File folder	
₃ Recent Pla	ces		FDC2x14_LDC13xxRevB_LDC16xxRevB_EV	6/12/2015 12:34 A	Text Document	101 KB
		=	HDC10x0_EVM_Firmware.txt	6/15/2015 11:08 PM	Text Document	93 KB
📜 Libraries			HDC20X0_EVM_Firmware.txt	9/22/2016 11:20 A	Text Document	100 KB
Document:	s					
🕹 Music le Pictures						
S Pictures						
J Mucos						
💐 Computer						
🧶 OSDisk (C:)						
IN VERBATIM	HD (G	₹ 4		Ш		•
	File n	ame:	HDC20X0_EVM_Firmware.txt	•	Text Document	-
					Open 🚬 🔻	Cancel
Connected	SSP	P EVM	connected - HDC20x0			

Figure 50. Selecting TI-TXT Firmware File for Upload to EVM

3. Click the "Upload Firmware" button.



GUI Operation

Z OneUI Application	
MENU Sensing Solutions EVM GUI	v1.9.1
Firmware Upgrade	
Select TI-TXT firmware File: C:\ti\Sensing Solutions EVM GUI-1.9.1\EVM Firmware\HDC20X0_EVM_Firmware.txt	
Connected SSP EVM connected - HDC20x0	TRUMENTS

Figure 51. Upload Firmware Button on Firmware Upload Page

4. Wait for the firmware to upload. Do NOT disconnect the EVM from the PC at this time! Also note that the GUI will disconnect from the EVM. The upload process should not take more than one minute.

Reversion Revers			
MENU Sensing Solutions EVM GUI		v1.9.1	1
Firmware Upgrade			
Select TI-TXT firmware File:			
Wait for upload to complete Uploading firmware: Please do NOT disconnect the EVM!			_
opiositiang initianato, ricado do NOT diadonandesario Erran			
Not connected SSP EVM disconnected	🖉 Texas Ins	TRUMI	ENTS

Figure 52. Firmware Upload in Progress



GUI Operation

ConeUI Application	
MENU Sensing Solutions EVM GUI	v1.9.1
Firmware Upgrade	
Select TI-TXT firmware File: C:\ti\Sensing Solutions EVM GUI-1.9.1\EVM Firmware\HDC20X0_EVM_Firmware.txt Upload Firmware	
Success!	
Connected SSP EVM connected - HDC20x0	Instruments

Figure 53. Firmware Upload Success

Board Layout

4 Board Layout

Figure 54 and Figure 55 show the board layout for the HDC2080EVM.

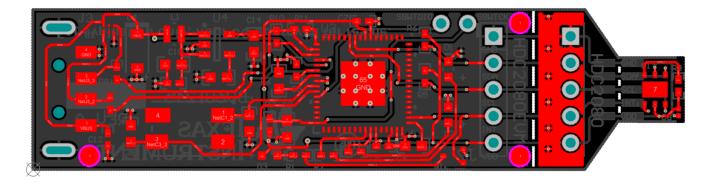


Figure 54. Top Layer Routing

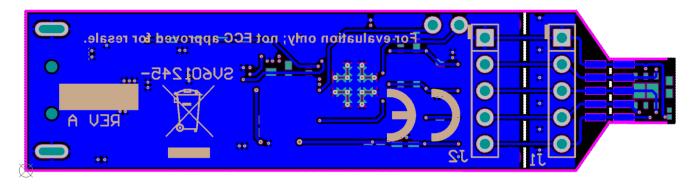
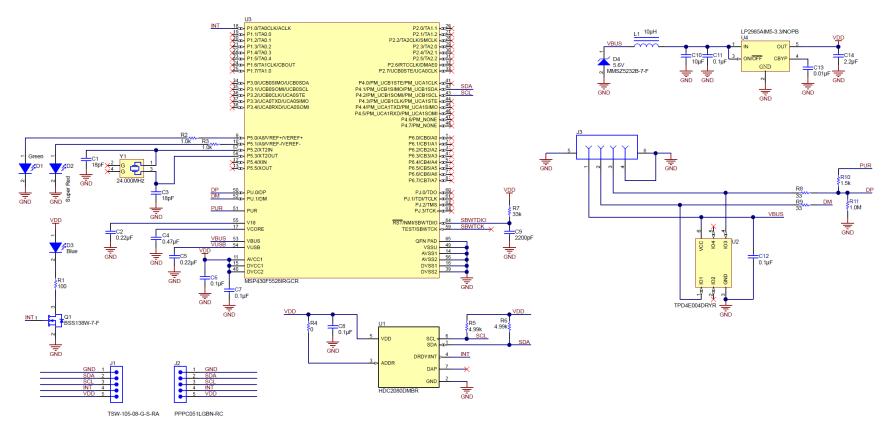


Figure 55. Bottom Layer Routing



Schematic

5 Schematic





6 HDC2080EVM Bill of Materials

REF DES	QTY	DESCRIPTION	FOOTPRINT	PART NUMBER
C1, C3	2	CAP, CERM, 18pF, 100V, +/-5%, C0G/NP0, 0603	0603	GRM1885C2A180JA01D
C2	1	CAP, CERM, 0.22uF, 25V, +/-10%, X5R, 0603	0603	06033D224KAT2A
C4	1	CAP, CERM, 0.47uF, 10V, +/-10%, X7R, 0603	0603	C0603C474K8RACTU
C5	1	CAP, CERM, 0.22uF, 16V, +/-10%, X7R, 0402	0402	GRM155R71C224KA12D
C6, C7, C11, C12	4	CAP, CERM, 0.1 µF, 16 V, +/- 10%, X7R, 0402	0402	GRM155R71C104KA88D
C8	1	CAP, CERM, 0.1uF, 10V, +/-10%, X5R, 0201	0201	CL03A104KP3NNNC
C9	1	CAP, CERM, 2200pF, 50V, +/-10%, X7R, 0603	0603	C0603X222K5RACTU
C10	1	CAP, CERM, 10uF, 10V, +/-20%, X5R, 0603	0603	C1608X5R1A106M
C13	1	CAP, CERM, 0.01uF, 25V, +/-5%, C0G/NP0, 0603	0603	C1608C0G1E103J
C14	1	CAP, CERM, 2.2uF, 10V, +/-10%, X5R, 0603	0603	C0603C225K8PACTU
D1	1	LED, Green, SMD	1.7x0.65x0.8mm	LG L29K-G2J1-24-Z
D2	1	LED, Super Red, SMD	LED, 1.6x.6x.8mm	SML-LX0603SRW-TR
D3	1	LED, Blue, SMD	BLUE 0603 LED	LB Q39G-L2N2-35-1
D4	1	Diode, Zener, 5.6V, 500mW, SOD-123	SOD-123	MMSZ5232B-7-F
J3	1	Connector, USB Type A, 4POS R/A, SMD	Edge mount USB A CONN	48037-2200
L1	1	Inductor, Shielded, Ferrite, 10uH, 0.4A, 1.38 ohm, SMD	2.0x0.95x1.6mm	VLS201610ET-100M
Q1	1	MOSFET, N-CH, 50 V, 0.2 A, SOT-323	SOT-323	BSS138W-7-F
R1	1	RES, 100, 5%, 0.063 W, 0402	0402	CRCW0402100RJNED
R2, R3	2	RES, 1.0k ohm, 5%, 0.063W, 0402	0402	CRCW04021K00JNED
R5, R6	2	RES, 4.99k ohm, 1%, 0.063W, 0402	0402	CRCW04024K99FKED
R7	1	RES, 33k ohm, 5%, 0.063W, 0402	0402	CRCW040233K0JNED
R8, R9	2	RES, 33 ohm, 5%, 0.063W, 0402	0402	CRCW040233R0JNED
R10	1	RES, 1.5 k, 5%, 0.063 W, 0402	0402	CRCW04021K50JNED
R11	1	RES, 1.0 M, 5%, 0.063 W, 0402	0402	CRCW04021M00JNED
U1	1	Low power humidity and temperature Digital Sensors, DMB006A	DMB0006A	HDC2080DMBR
U2	1	4-CHANNEL ESD-PROTECTION ARRAY FOR HIGH-SPEED DATA INTERFACES, DRY006A	DRY0006A	TPD4E004DRYR
U3	1	Mixed Signal MicroController, RGC0064B	RGC0064B	MSP430F5528IRGCR
U4	1	Micropower 150 mA Low-Noise Ultra Low- Dropout Regulator, 5-pin SOT-23, Pb-Free	MF05A	LP2985AIM5-3.3/NOPB
Y1	1	Crystal, 24.000MHz, 18pF, SMD	Xtal, 7.2x1.3x5.2mm	ABMM-24.000MHZ-B2-T
FID1, FID2, FID3	0	Fiducial mark. There is nothing to buy or mount.	Fiducial	N/A
J1, J2	0	Header, TH, 100mil, 5x1, Gold plated, 230 mil above insulator	5x1 Header	TSW-105-07-G-S
R4	0	RES, 0, 5%, 0.063 W, 0402	0402	CRCW04020000Z0ED



Revision History

DATE	REVISION	NOTES
April 2018	*	Initial release.

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CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

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- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

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Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

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